

April 2000

# FQP4N60

# **600V N-Channel MOSFET**

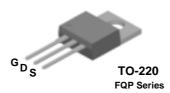
## **General Description**

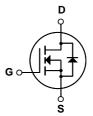
These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supply.

#### **Features**

- 4.4A, 600V,  $R_{DS(on)}$  = 2.2 $\Omega$  @V<sub>GS</sub> = 10 V Low gate charge ( typical 15 nC)
- Low Crss (typical 8.0 pF)
- · Fast switching
- 100% avalanche tested
- · Improved dv/dt capability





# **Absolute Maximum Ratings** $T_C = 25$ °C unless otherwise noted

Symbol	Parameter		FQP4N60	Units	
V <sub>DSS</sub>	Drain-Source Voltage		600	V	
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25°C) - Continuous (T <sub>C</sub> = 100°C)		4.4	А	
			2.8	А	
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	17.6	А	
V <sub>GSS</sub>	Gate-Source Voltage		± 30	V	
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	260	mJ	
I <sub>AR</sub>	Avalanche Current	(Note 1)	4.4	А	
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	10.6	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns	
$P_{D}$	Power Dissipation (T <sub>C</sub> = 25°C) - Derate above 25°C		106	W	
			0.85	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C	
T <sub>L</sub>	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	

## **Thermal Characteristics**

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		1.18	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink	0.5		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

Symbol	Parameter	Test Conditions	3	Min	Тур	Max	Units
Off Cha	aracteristics						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600			V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 μA, Referenced	to 25°C		0.6		V/°C
I <sub>DSS</sub>	Zana Cata Valtana Busin Comuni	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V				10	μΑ
	Zero Gate Voltage Drain Current	$V_{DS} = 480 \text{ V}, T_{C} = 125^{\circ}\text{C}$			-	100	μΑ
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$			-	100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA
On Cha	aracteristics						
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		3.0		5.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 2.2 A			1.77	2.2	Ω
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 2.2 A	(Note 4)		4.0		S
C <sub>oss</sub>	Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0  MHz			70 8	90 11	pF pF
C <sub>rss</sub>	Reverse Transfer Capacitance				8	11	pF
Switch	ing Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD}$ = 300 V, $I_{D}$ = 4.4 A, $R_{G}$ = 25 $\Omega$			13	35	ns
t <sub>r</sub>	Turn-On Rise Time				45	100	ns
t <sub>d(off)</sub>	Turn-Off Delay Time				25	60	ns
t <sub>f</sub>	Turn-Off Fall Time		(Note 4, 5)		35	80	ns
$Q_g$	Total Gate Charge	$V_{DS} = 480 \text{ V}, I_{D} = 4.4 \text{ A},$			15	20	nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> = 10 V (Note 4, 5)			3.4		nC
$Q_{gd}$	Gate-Drain Charge				7.1		nC
Drain-9	Source Diode Characteristics ar	nd Maximum Rating	s				
Dialif	Maximum Continuous Drain-Source Diode Forward Current					4.4	Α
	Maximum Continuous Drain-Source Dic	Maximum Pulsed Drain-Source Diode Forward Current		<b> </b>			
I <sub>S</sub>		Forward Current				17.6	Α
I <sub>S</sub>		Forward Current V <sub>GS</sub> = 0 V, I <sub>S</sub> = 4.4 A				17.6	V
I <sub>S</sub>	Maximum Pulsed Drain-Source Diode F				  250		

- **Notes:**1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 25mH, I<sub>AS</sub> = 4.4A, V<sub>DD</sub> = 50V, R<sub>G</sub> = 25  $\Omega$ , Starting T<sub>J</sub> = 25°C 3. I<sub>gD</sub> ≤ 4.4A, di/dt ≤ 200A/µs, V<sub>DD</sub> ≤ BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25°C 4. Pulse Test : Pulse width ≤ 300µs, Duty cycle ≤ 2% 5. Essentially independent of operating temperature

# **Typical Characteristics**

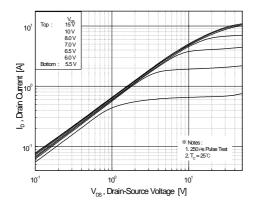


Figure 1. On-Region Characteristics

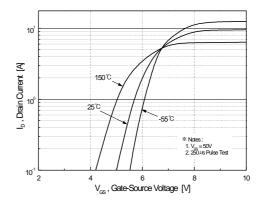


Figure 2. Transfer Characteristics

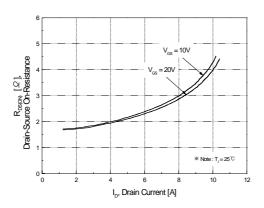


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

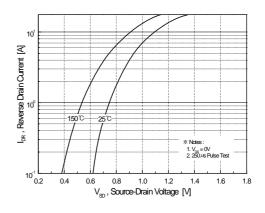


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

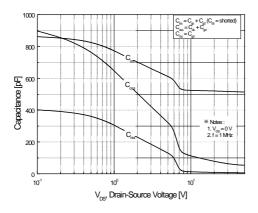


Figure 5. Capacitance Characteristics

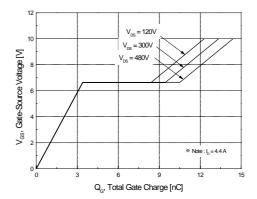
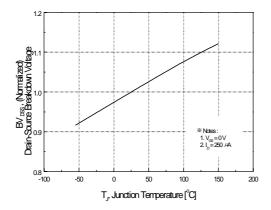


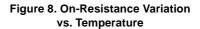
Figure 6. Gate Charge Characteristics

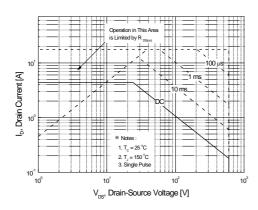
# Typical Characteristics (Continued)



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Figure 7. Breakdown Voltage Variation vs. Temperature





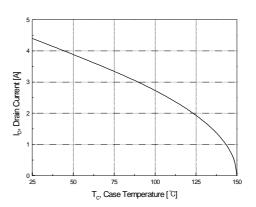


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

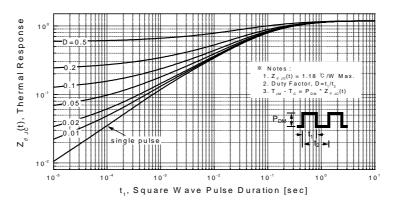
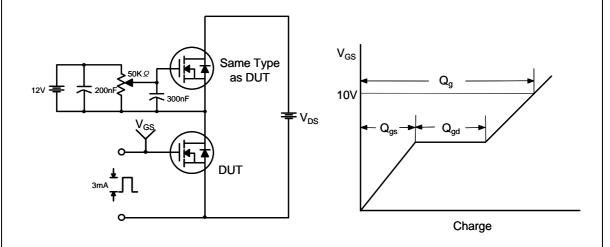


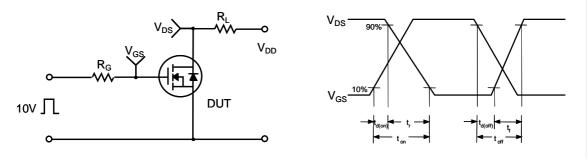
Figure 11. Transient Thermal Response Curve

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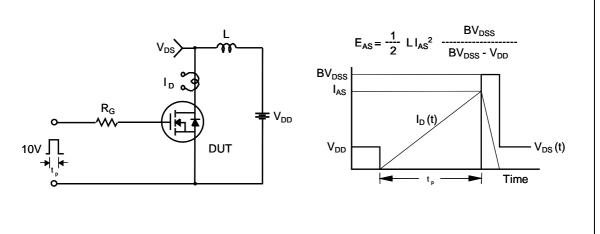
## **Gate Charge Test Circuit & Waveform**



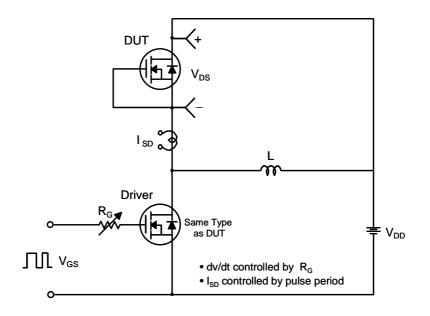
## **Resistive Switching Test Circuit & Waveforms**

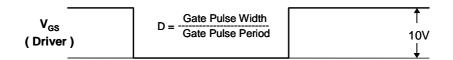


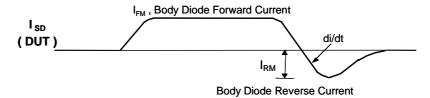
## **Unclamped Inductive Switching Test Circuit & Waveforms**

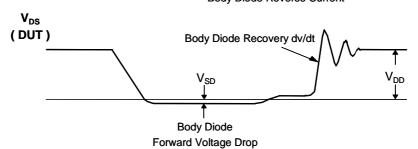


## Peak Diode Recovery dv/dt Test Circuit & Waveforms

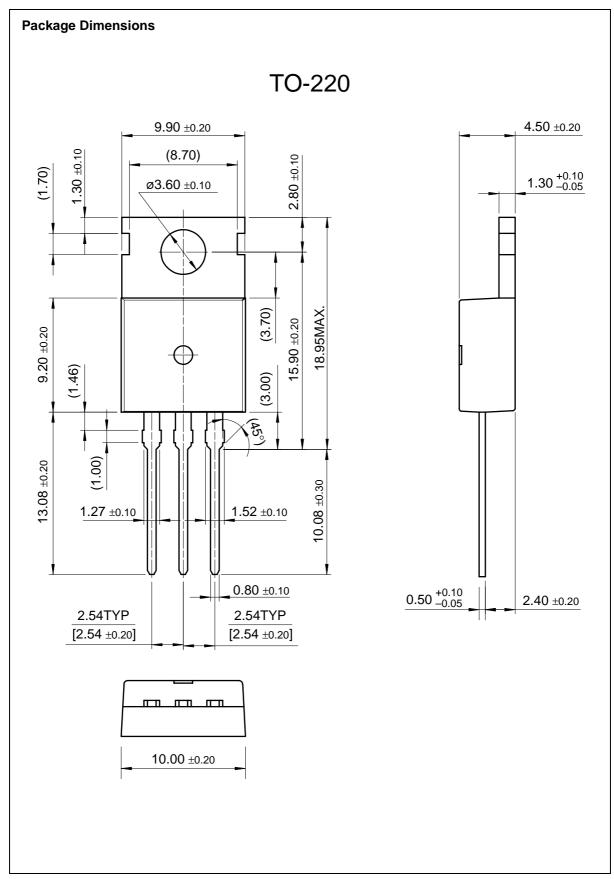








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